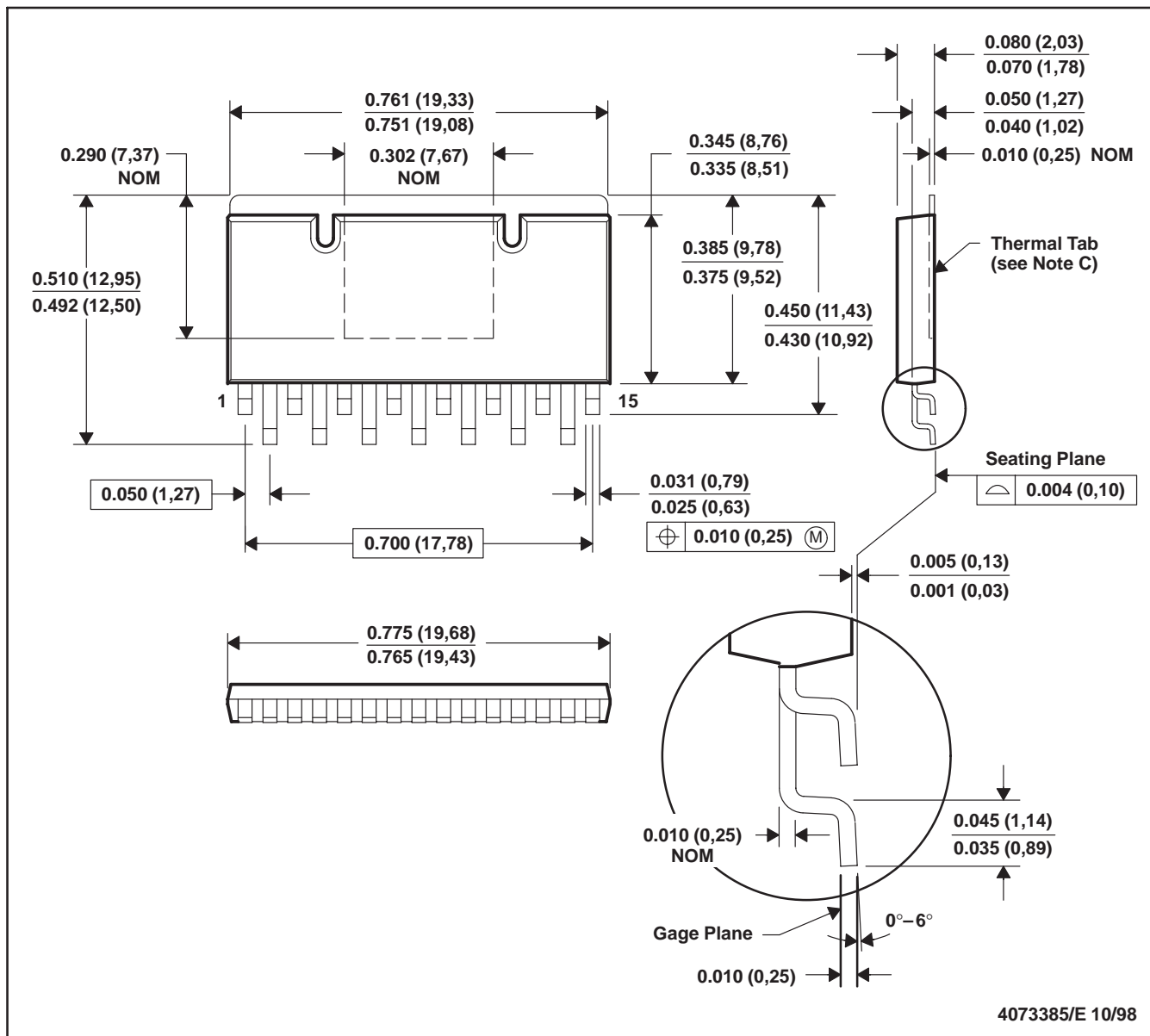


KTC (R-PSFM-G15)

PowerFLEX™ PLASTIC FLANGE-MOUNT



- NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.
 C. The heatsink area is approximately 78K sq mils.
 D. Dimensions do not include mold protrusions, not to exceed 0.006 (0,15).

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